

**Reliability Test**

**1-1 Electrical Performance**

No.	Item	Specification	Test Method
1-1-1	Inductance	Refer To Standard Electrical Characteristic List.	HP 4291A + HP16193A
1-1-2	Q		HP 4291A + HP16193A
1-1-3	SRF		HP 8753D
1-1-4	DC Resistance Rdc		DIGITAL MULTIMETER SC-7401
1-1-5	Rated Current Idc		Applied The Current To Coils, The Inductance Change Should Be Less Than 10% To Initial Value.
1-1-6	Over Load Test	After Test, Inductors Shall Be No Evidence Of Electrical And Mechanical Damage.	Applied 2 Times $\bar{C}$ Rated Allowed DC Current To Inductor For A Period Of 5 Minute.
1-1-7	Withstanding Voltage Test	After Test, Inductors Shall Be No Evidence Of Electrical And Mechanical Damage.	AC Voltage Of 500 VAC Applied Between Inductors Terminal And Case For 1 Minute.
1-1-8	Insulation Resistance Test	1000M ohms Min.	100 VDC Applied Between Inductor Terminal And Case

**1-2 Environmental Performance**

No.	Item	Specification	Test Method															
1-2-1	Temperature Cycle	Appearance: No Damage L change: Within $\pm 10\%$ Q change: Within $\pm 20\%$	One Cycle: <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>Step</th> <th>Temperature ( )</th> <th>Time (min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-25 <math>\pm 3</math></td> <td>30</td> </tr> <tr> <td>2</td> <td>25 <math>\pm 2</math></td> <td>15</td> </tr> <tr> <td>3</td> <td>85 <math>\pm 3</math></td> <td>30</td> </tr> <tr> <td>4</td> <td>25 <math>\pm 2</math></td> <td>15</td> </tr> </tbody> </table> Total: 5 cycles Measured After Exposure In The Room Condition For 1Hrs	Step	Temperature ( )	Time (min.)	1	-25 $\pm 3$	30	2	25 $\pm 2$	15	3	85 $\pm 3$	30	4	25 $\pm 2$	15
Step	Temperature ( )		Time (min.)															
1	-25 $\pm 3$		30															
2	25 $\pm 2$		15															
3	85 $\pm 3$	30																
4	25 $\pm 2$	15																
1-2-2	Humidity Resistance	Temperature: 40 $\pm 2$ Relative Humidity: 90 ~ 95% Time: 100Hrs Measured After Exposure In The Room Condition For 1Hrs																
1-2-3	High Temperature Resistance	Temperature: 125 $\pm 3$ Time: 50Hrs Measured After Exposure In The Room Condition For 1Hrs																
1-2-4	Low Temperature Resistance	Temperature: -40 $\pm 3$ Time: 50Hrs Measured After Exposure In The Room Condition For 1Hrs																
1-2-5	High Temperature Load Life	There Should Be No Evidence Of Short Or Open Circle	Temperature: 85 $\pm 3$ Load: Allowed DC Current Time: 1000Hrs															
1-2-6	Humidity Load Life		Temperature: 40 $\pm 2$ Relative Humidity: 90 ~ 95% Load: Allowed DC Current Time: 1000Hrs															



## Open Type Wire Wound Chip Inductors / Ceramic Series

### 1-3 Mechanical Performance

No.	Item	Specification	Test Method
1-3-1	Vibration Test (Low Frequency)	1. Appearance: No damage 2. L change: within $\pm 5\%$ 3. Q change: within $\pm 10\%$	1. Test Device Shall Be Soldered On The Substrate. 2. Oscillation Frequency: 10 to 55 to 10Hz for 1min. 3. Amplitude: 1.5mm 4. Time: 2hrs For Each Axis (X, Y & Z), Total 6hrs
1-3-2	Resistance To Soldering Heat	Appearance: No Damage	1. Pre-Heating: 150 , 1min. 2. Solder Composition: Sn/Pb = 63/37. 3. Solder Temperature: 260 $\pm 5$ . 4. Immersion Time: 10 $\pm 1$ sec.
1-3-3	Solderability	The Electrodes Shall Be At Least 90% Covered With New Solder Coating	1. Pre-Heating: 150 , 1min. 2. Solder Composition: Sn/Pb = 63/37. 3. Solder Temperature: 230 $\pm 5$ . 4. Immersion Time: 4 $\pm 1$ sec.
1-3-4	Component Adhesion (Push Test)	2 Lbs. For 0603 4 Lbs. For The Rest	The Device Should Be Reflow Soldered (230 $\pm 5$ For 10 Seconds) To A Tinned Copper Substrate. A Force Gauge Should Be Applied To The Side Of The Component. The Device Must Withstand A Minimum Force Of 2 Or 4 Pounds Without A Failure Of The Termination Attached To Component.